



**Faculty of Manufacturing Engineering**

**EFFECT OF CARBON ADDITIVES AND SURFACTANT ON  
ELECTRICAL DISCHARGE MACHINING (EDM) OF  
REACTION-BONDED SILICON CARBIDE (RB-SiC)**

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ELECTRICAL DISCHARGE MACHINING (EDM) OF  
REACTION-BONDED SILICON CARBIDE (RB-SiC)**

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**A thesis submitted  
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**2017**

## DECLARATION

I declare that this thesis entitled “Effect of Carbon Additives and Surfactant on Electrical Discharge Machining (EDM) of Reaction-Bonded Silicon Carbide (RB-SiC)” is the result of my own research except as cited in the references. The thesis has not been accepted for any degree and is not concurrently submitted in candidature of any other degree.

Signature : .....

Name : .....

Date : .....

## **APPROVAL**

I hereby declare that I have read this thesis and in my opinion this thesis is sufficient in terms of scope and quality for the award of Master of Science in Manufacturing Engineering.

Signature : .....

Supervisor Name : .....

Date : .....

## **DEDICATION**

I dedicated this thesis to my beloved family.

Abdul Razak Bin Ahmad

Aisah Binti Biran

Nurul Suhaidah Binti Abdul Razak (sister)

and

to all my friends

## ABSTRACT

Reaction-bonded silicon carbide (RB-SiC) is an important material in the manufacturing industry due to its excellent material properties. However, due to its high hardness, there are difficulties in machining this material to a good surface finish and with a high level of accuracy. To overcome these problems during the machining of ceramic materials, electrical discharge machining (EDM) is employed. Thus, the primary aim of this research is to conduct a comparative study of EDM on this material using different types of surfactant, concentrations of surfactant and carbon additive. The dielectric fluid, kerosene was mixed with different surfactants, namely Span 20 and Span 80. In order to investigate the effects of the surfactants, different concentrations of surfactant, namely 0 wt.%, 0.4 wt.%, 0.6 wt.% and 0.8 wt.%, were used. Carbon nanofiber (CNF), carbon nano powder (CNP) and carbon powder (CP) were used as an additives in this experiment. These powders are different in terms of size and shape. The responses of the machining, such as the stability of mixtures, material removal rate (MRR), electrode wear ratio (EWR), surface roughness, spark gap and surface topography, were also investigated. The results show that the surfactant and additives added to the dielectric fluid not only improved MRR and spark gap, but also reduced EWR, especially for the surfactant Span 80. The addition of a surfactant can prevent the agglomeration of powders and cause the powders to disperse well within the dielectric fluid. Therefore, the electro discharge frequency is increased, leading to a higher MRR and spark gap. The optimum weight percentage of surfactant concentration for obtaining smoother surface was at 0.4 wt.%. In terms of additives, CNF showed significant changes for MRR and EWR compared to CNP and CP. For comparison, the combination of surfactant Span 80 with 0.6 wt.% concentration of surfactant and CNF as additive is more significant in improving the machining efficiency of RB-SiC using conventional EDM compared to other surfactants, concentrations and additive powders.

## ABSTRAK

*Tindak balas terikat silikon karbida (RB-SiC) adalah bahan yang penting di dalam industri pembuatan disebabkan oleh sifat bahannya yang baik. Bagaimanapun, disebabkan mempunyai kekerasan yang tinggi, bahan ini sukar dimesin bagi menghasilkan kemas permukaan yang baik dan berketepatan tinggi. Bagi mengatasi masalah permesinan bahan seramik, mesin penyahcas elektrik (EDM) telah digunakan. Oleh itu, tujuan utama kajian ini adalah untuk mengkaji perbandingan prestasi EDM bagi bahan ini dengan menggunakan jenis surfaktan, kepekatan surfaktan dan serbuk aditif yang berbeza. Cecair dielektrik jenis kerosin digunakan dalam eksperimen ini dicampur dengan surfaktan yang berbeza iaitu Span 20 dan Span 80. Bagi mengkaji kesan surfaktan, peratusan berat surfaktan yang berbeza digunakan iaitu 0 wt%, 0.4 wt%, 0.6 wt% dan 0.8 wt%. Karbon aditif yang digunakan bagi membantu keberkesanan permesinan adalah fiber nano karbon (CNF), serbuk nano karbon (CNP) dan serbuk karbon (CP). Perbezaan diantara ketiga-tiga serbuk ini adalah dari segi saiz dan bentuk. Respon pemesinan yang dikaji adalah seperti kestabilan campuran, kadar pembuangan bahan (MRR), nisbah kehausan elektrod (EWR), kekasaran permukaan, jurang percikan dan permukaan topografi. Keputusan menunjukkan bahawa surfaktan dan serbuk aditif yang dicampurkan ke dalam cecair dielektrik bukan sahaja meningkatkan nilai MRR dan jurang percikan malah mengurangkan nilai EWR terutama sekali surfaktan Span 80. Penambahan surfaktan dapat menghalang serbuk daripada bergumpal, dan menyebabkan serbuk aditif berserakan dengan baik di dalam cecair dielektrik. Maka, kekerapan perlepasan elektro dapat ditingkatkan dan menyebabkan MRR dan jurang percikan tinggi. Peratusan berat optimum surfaktan yang menghasilkan kemas permukaan yang baik adalah pada 0.4wt.%. Dari segi aditif, CNF menunjukkan perubahan yang ketara untuk MRR dan EWR berbanding CNP dan CP. Untuk perbandingan, kombinasi surfaktan Span 80 dengan kepekatan surfaktan 0.6wt% dan CNF sebagai aditif menunjukkan perubahan ketara bagi meningkatkan kecekapan permesinan untuk RB-SiC menggunakan konvensional EDM berbanding surfaktan yang lain, kepekatan dan juga serbuk aditif yang lain.*

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## TABLE OF CONTENTS

	<b>PAGE</b>
<b>DECLARATION</b>	
<b>DEDICATION</b>	
<b>ABSTRACT</b>	<b>i</b>
<b>ABSTRAK</b>	<b>ii</b>
<b>ACKNOWLEDGEMENTS</b>	<b>iii</b>
<b>TABLE OF CONTENTS</b>	<b>iv</b>
<b>LIST OF TABLES</b>	<b>vii</b>
<b>LIST OF FIGURES</b>	<b>ix</b>
<b>LIST OF APPENDICES</b>	<b>xiii</b>
<b>LIST OF ABBREVIATIONS</b>	<b>xiv</b>
<b>LIST OF SYMBOLS</b>	<b>xvi</b>
<b>LIST OF PUBLICATIONS</b>	<b>xviii</b>
<b>CHAPTER</b>	
<b>1. INTRODUCTION</b>	<b>1</b>
1.1 Research Background	1
1.2 Problem Statement	4
1.3 Research Objectives	5
1.4 Scope of Research	5
1.5 Significance of Research	6
1.6 Organization of the Thesis	6
<b>2. LITERATURE REVIEW</b>	<b>8</b>
2.1 Electric Discharge Machining (EDM)	8
2.2 The Principle of EDM	10
2.3 Types of EDM	13
2.3.1 Die-sinker EDM	13
2.3.2 Wire-cut EDM	14
2.3.3 Application of EDM	15
2.4 Parameters of EDM	16
2.4.1 Discharge current	18
2.4.2 Pulse On-Time	18
2.4.3 Pulse Off-Time	18
2.4.4 Dielectric Fluid	19
2.4.5 Flushing	22
2.4.6 Electrode	23
2.5 EDM Variants	24
2.5.1 Micro EDM	24
2.5.2 Dry EDM	24
2.5.3 Powder mixed electrical discharge machining (PMEDM)	24
2.5.4 Previous Studies of PMEDM	27
2.5.5 Method to disperse the additives powder	29
2.6 Surfactant	33
2.6.1 Types of Surfactant	34
2.6.2 Previous Studies on Surfactant for EDM	35

2.7	Reaction Bonded Silicon Carbide (RB-SiC)	38
2.7.1	Material properties and Microstructure	38
2.7.2	Application of RB-SiC	40
2.7.3	Machining Process for RB-SiC	41
2.8	EDM Mixture Stability	43
2.9	EDM Performance Measures	45
2.9.1	Material Removal Rate (MRR)	46
2.9.2	Electrode Wear Ratio (EWR)	48
2.9.3	Surface Roughness	49
2.9.4	Surface Topography	50
2.9.5	Spark Gap	53
2.10	Summary of Literature Review	55
<b>3.</b>	<b>METHODOLOGY</b>	<b>56</b>
3.1	Gantt Chart	56
3.2	Project Flow Chart	56
3.3	Experimental Methods	58
3.3.1	Machine Tool	58
3.3.2	Workpiece Material	59
3.3.3	Electrode Material	60
3.3.4	Dielectric Fluid	61
3.3.5	Surfactant	63
3.3.6	Carbon Additives	64
3.4	Preparation of EDM Mixture	66
3.5	Experimental Procedure	68
3.5.1	Electrode and Material Preparation	68
3.5.2	Machine tool setting	72
3.5.3	Data Collection	73
3.6	Measurement and Analysis	74
3.6.1	Stability of EDM Mixture	74
3.6.2	Material Removal Rate (MRR)	75
3.6.3	Electrode Wear Ratio (EWR)	76
3.6.4	Surface Roughness	76
3.6.5	Spark Gap	77
3.6.6	Surface Topography	78
<b>4.</b>	<b>RESULT AND DISCUSSION</b>	<b>80</b>
4.1	Stability of the EDM Mixture	80
4.1.1	EDM Mixture Observation	80
4.1.2	Zeta Potential Analysis	83
4.2	Effect of Surfactant with Carbon Nanofiber (CNF)	84
4.2.1	Material Removal Rate (MRR)	84
4.2.2	Electrode Wear Ratio (EWR)	86
4.2.3	Surface Roughness	88
4.2.4	Spark Gap	90
4.2.5	Surface Topography	92
4.2.6	Material Removal Mechanism	96

4.3	Effect of Surfactant Span 80 with Different Additive Powders	97
4.3.1	EDM Mixture Observation	98
4.3.2	Zeta Potential Analysis	99
4.3.3	Material Removal Rate (MRR)	100
4.3.4	Electrode Wear Ratio (EWR)	102
4.3.5	Surface Roughness	104
4.3.6	Spark Gap	105
4.3.7	Surface Topography	107
4.4	Process Mechanism	109
<b>5.</b>	<b>CONCLUSION, CONTRIBUTION AND RECOMMENDATIONS</b>	<b>114</b>
5.1	Conclusions	114
5.2	Research Contributions	115
5.3	Recommendations	116
	<b>REFERENCES</b>	<b>117</b>
	<b>APPENDICES</b>	<b>134</b>

## LIST OF TABLES

<b>TABLE</b>	<b>TITLE</b>	<b>PAGE</b>
2.1	Parameters of EDM	17
2.2	Comparison between SiC material, aluminium and steel	39
3.1	Properties of RB-SiC	60
3.2	Properties of copper electrode	61
3.3	Chemical and physical properties of kerosene	62
3.4	Chemical properties of the surfactant	63
3.5	Details of carbon additives	64
3.6	Description of the composition of the EDM mixture	66
3.7	Experimental conditions of EDM	73
4.1	EDM Mixture observation for different surfactant	82
4.2	Result of MRR for different surfactants mixed with CNF	84
4.3	Result of the EWR for different surfactants mixed with CNF	86
4.4	Result of surface roughness for different surfactants mixed with CNF	88
4.5	Result of spark gap for different surfactant mixed with CNF	90
4.6	EDM mixture observation for different additives	98
4.7	Result of MRR for surfactant Span 80 mixed with different additives	100
4.8	Result of EWR for surfactant Span 80 mixed with different additives	102

4.9	Result of surface roughness with surfactant Span 80 mixed with different additives	104
4.10	Result of spark gap for surfactant Span 80 mixed with different additives	105

## LIST OF FIGURES

<b>FIGURE</b>	<b>TITLE</b>	<b>PAGE</b>
1.1	Basic components of EDM	3
2.1	Surgical instruments made with the EDM process	10
2.2	Electrical discharge phases	12
2.3	Die-sinker EDM	14
2.4	Wire-cut EDM	15
2.5	Pulse wave from pulse generator	19
2.6	Powder mixed EDM	25
2.7	Effect of additives powder suspended in the dielectric fluid on the sparking mechanism	26
2.8	Test equipment for powder suspension in dielectric fluid	29
2.9	Experiment setup using a mud pump to disperse the additives powder	31
2.10	Experimental setup for machining with ultrasonic vibration of dielectric fluid	31
2.11	Experiment setup using an oscillator horn	32
2.12	Illustration of additives powders disperse by surfactant molecules	37
2.13	RB-SiC from laser sintered preform	39
2.14	Product from Reaction Bonded Silicon Carbide (RB-SiC) for various applications	40
2.15	Biomedical devices	41

2.16	Condition of carbon nanotubes based nanofluids without surfactant	43
2.17	Photos of different EDM dielectrics holding for 7 days	44
2.18	Stability of carbon nanotube based nanofluids	45
2.19	Spalled area of parent material by removal of flake immediately prior to detachment	47
2.20	Arithmetic average roughness value, $R_a$	49
2.21	SEM micrographs of machined surface under various polarities and dielectrics	52
2.22	Machined surface characteristics under different discharge current, surfactant concentration and graphite powder concentration	53
3.1	Flow chart of the experiment	57
3.2	EDM die sinker model Sodick AQ35L	58
3.3	Microstructures of RB-SiC that observed by Transmission Electron microscopy (TEM)	59
3.4	Copper electrode as an electrode	60
3.5	EDM Oil LS from Global Work Co. Ltd, Thailand	62
3.6	Surfactant Span series	63
3.7	FE-SEM micrographs of different types of additives	65
3.8	Ultrasonic Homogenizer model Labsonic type P series	67
3.9	Condition of the EDM mixture preparation	68
3.10	Electrode dressing process	69
3.11	Optical Microscope model EMZ-13TR form Meiji Techno	70
3.12	Digital analytical balance by Mettler Toledo model AB135-S	70
3.13	(a) Electrode assemble on holder and (b) workpiece mounted on jig	71
3.14	Condition of EDM machining experiment	72
3.15	Sample for observation	74

3.16	Equipment for Zeta potential analysis	75
3.17	Mitutoyo SJ-410 Surface Roughness tester	77
3.18	Schematic diagram for spark gap calculation	78
3.19	Scanning Electron Microscope (SEM) Machine	79
4.1	Zeta potential analysis for different surfactant with CNF as additives	83
4.2	Effect of surfactant concentration on MRR for different surfactants	85
4.3	Effect of surfactant concentration on EWR for different surfactants	87
4.4	Effect of surfactant concentration on surface roughness for different surfactants	89
4.5	Effect of surfactant concentration on spark gap for different surfactant	91
4.6	Surface topography of samples machined with EDM using several different surfactants. Images were gathered by scanning electron microscopy (SEM)	93
4.7	Surface topography of samples machined with EDM conditions for several different concentration using surfactant Span 80	94
4.8	Machined surface using 0.6 wt% concentration of surfactant Span 80	96
4.9	Zeta potential analysis for surfactant Span 80 with different additives	99
4.10	Effect of different additives powder using different concentrations of surfactant Span 80 on the MRR	101
4.11	Effect of different additives powder using surfactant Span 80 on EWR	103
4.12	Effect of different additives powder using surfactant Span 80 on surface roughness	104
4.13	Effect of different additives powder using surfactant Span 80 on spark gap	106
4.14	Machine surface of RB-SiC under different additives	108



4.15	Schematic model for carbon nanofiber (CNF) with surfactant	109
4.16	Illustration of carbon particles disperse by surfactant molecules	111
4.17	Schematic model for carbon nanopowder (CNP) with surfactant	112
4.18	Schematic model for carbon powder (CP) with surfactant	113

## LIST OF APPENDICES

<b>APPENDIX</b>	<b>TITLE</b>	<b>PAGE</b>
A	Gantt Chart of Research	134
B	Raw data for MRR	135
C	Raw data for EWR	137
D	Raw data for surface roughness	139
E	Raw data for spark gap	141

## LIST OF ABBREVIATIONS

Al	-	Aluminium
Al <sub>2</sub> O <sub>3</sub>	-	Aluminium Oxide
B <sub>4</sub> C	-	Boron carbide
BMI	-	Brain Machine Interface
CNF	-	Carbon Nanofiber
CNP	-	Carbon Nanopowder
CNT	-	Carbon Nanotube
CP	-	Carbon Powder
CTAB	-	Cetyltrimethylammonium bromide
DESSEDG	-	Double Electrode Synchronous Servo Electrical Discharge Grinding
DTAB	-	Dodecyltrimethylammonium bromide
EDM	-	Electrical Discharge Machining
EWR	-	Electrode Wear Ratio
FE-SEM	-	Field Emission Scanning Electron Microscopy
GA	-	Gum Arabic
HLB	-	Hydrophilic–Lipophilic Balance
RB-SiC	-	Reaction Bonded Silicon Carbide
SEM	-	Scanning Electron Microscopy

MRR	-	Material Removal Rate
NaDDBS	-	Dodecyl Benzene Sodium Sulfonate
PMEDM	-	Powder Mixed EDM
SDBS	-	Sodium Dodecyl Benzene Sulfonate
SDS	-	Sodium Dodecyl Sulphate
MMC	-	Metal Matrix Composites
$\alpha$ -SiC	-	Alpha Silicon Carbide
$\beta$ -SiC	-	Cubic Silicon Carbide
SiC	-	Silicon Carbide
SiSiC	-	Silicon Infiltrated Silicon Carbide
TEM	-	Transmission Electron Microscopy
Ti-6Al-4V	-	Titanium Alloy
Triton X-100	-	Octyl Phenol Ethoxylate
WC-Co	-	Cobalt-Bonded Tungsten Carbide
WEDM	-	Wire Electrical Discharge Machining
ZrO <sub>2</sub>	-	Zirconium Dioxide
3D	-	Three Dimensional

## LIST OF SYMBOLS

A	-	ampere
MPa	-	megapascal
GPa	-	gigapascal
Hz	-	hertz
kHz	-	kilohertz
HV	-	vickers pyramid number
g	-	gram
g/lit	-	gram per liter
g/cm <sup>3</sup>	-	gram per cubic centimeter
nm	-	nanometer
μm	-	micrometer
μs	-	microsecond
mm <sup>3</sup> /min	-	cubic milimeter per minute
mm <sup>3</sup>	-	cubic milimeter
mm <sup>2</sup> /s	-	square milimeter per second
mg/min	-	miligram per minutes
mm/s	-	milimeter per second
mm	-	milimeter
ml	-	mililiter

min	-	minute
mg KOH/g	-	milligrams of potassium hydroxide per gram
kg/m <sup>3</sup>	-	kilogram per cubic meter
kPa	-	kilopaskal
K <sup>-1</sup>	-	per kelvin
R <sub>a</sub>	-	roughness average
R <sub>q</sub>	-	RMS Roughness
R <sub>z</sub>	-	average maximum peak
V	-	voltage
mV	-	milivolts
W/mK	-	watts per meter kelvin
wt. %	-	weight percentage
%	-	percent
°F	-	degree fahrenheit
°C	-	degree celsius
Ω.cm	-	ohm centimeter
μΩ.cm	-	microhm centimeter

## LIST OF PUBLICATIONS

### Award

1. **Abdul Razak, M.R.**, Liew, P.J., Hussein, N.I.S., and Ahsan, Q., 2016. Effect of Surfactants and Additives on Electrical Discharge Machining of Reaction Bonded Silicon Carbide. *International Conference on Engineering and ICT (ICEI 2016)*, Hatten Hotel, Melaka, Malaysia, 4 -6 April 2016 . **(Best Paper Award)**

### Journal

1. **Abdul Razak, M.R.**, Liew, P.J., Hussein, N.I.S., and Ahsan, Q., 2016. Effect of Surfactant on EDM of Low Conductivity Reaction-Bonded Silicon Carbide. *Key Engineering Materials, Vol. 701*, pp.107-111 (Scopus)( Accepted).
2. **Abdul Razak, M.R.**, Liew, P.J., Hussein, N.I.S., and Ahsan, Q. Effect of Surfactants and Additives on Electrical Discharge Machining of Reaction Bonded Silicon Carbide. *International Journal of Automotive and Mechanical Engineering*, (Scopus)(Submitted).
3. Liew, P.J., **Abdul Razak, M.R.**, Hussein, N.I.S., and Ahsan, Q. Experimental Investigation of Electrical Discharge Machining using Dielectric Fluid with Surfactant and Different Carbon Additives. *International Journal of Applied Engineering Research (IJAER)*, (Scopus) (Accepted).

## **Conference Paper**

1. **Abdul Razak, M.R.**, Liew, P.J., Hussein, N.I.S., and Ahsan, Q., 2016. Effect of Surfactant on EDM of Low Conductivity Reaction-Bonded Silicon Carbide. *2nd International Conference on the Science and Engineering of Materials (ICoSEM 2015)*, Kuala Lumpur, Malaysia, 16 -18 November 2015.
2. **Abdul Razak, M.R.**, Liew, P.J., Hussein, N.I.S., and Ahsan, Q., 2016. Effect of Surfactants and Additives on Electrical Discharge Machining of Reaction Bonded Silicon Carbide. *International Conference on Engineering and ICT (ICEI 2016)*, Melaka, Malaysia, 4 -6 April 2016.